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PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3106647

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SIMONE MERLIN	09/26/2014
BIN TIAN	10/06/2014
SAMEER VERMANI	10/10/2014
EUGENE JONG-HYON BAIK	09/11/2014

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121

PROPERTY NUMBERS Total: 2

Property Type	Number
Application Number:	14321331
Application Number:	61843315

CORRESPONDENCE DATA

Fax Number: (949)760-9502

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 949-760-0404 **Email:** efiling@knobbe.com

Correspondent Name: KNOBBE, MARTENS, OLSON & BEAR, LLP

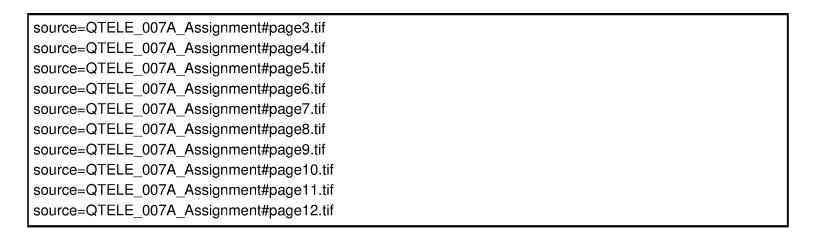
Address Line 1: 2040 MAIN STREET, 14TH FLOOR

Address Line 4: IRVINE, CALIFORNIA 92614

ATTORNEY DOCKET NUMBER:	QTELE.007A
NAME OF SUBMITTER:	FRED NICHOLSON
SIGNATURE:	/Fred Nicholson/
DATE SIGNED:	11/13/2014

Total Attachments: 12

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WHEREAS, WE,

- 1. Simone Merlin, a citizen of Italy, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A. and a resident of San Diego, California,
- 2. **Bin Tian**, a citizen of U.S.A., having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A. and a resident of San Diego, California,
- 3. Sameer Vermani, a citizen of India, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A and a resident of Solana Beach, California.
- 4. Engene Jong-Hyon Baik, a citizen of U.S.A., having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A and a resident of San Diego, California.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to METHODS AND APPARATUS FOR CLEAR CHANNEL ASSESSMENT (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 14/321,331, filed July 1, 2014, Qualcomm Reference No. 133764, and all provisional applications relating thereto, together with U.S. Provisional Application No(s). 61/843,6315, filed July 5, 2013, Qualcomm Reference No. 133764P1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

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	LOCATION	DATE	Simone Merlin
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	LOCATION	DATE	Bin Tian
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	LOCATION	DATE	Sameer Vermani
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	LOCATION	130 I H	Fucene Jong-Hyon Baik

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-	LOCATION	DATE	Simone Merlin
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	LOCATION	DATE	Bin Tian
Done at	LOCATION , or	n	
	LOCATION	DATE	Sameer Vermani
Done at	, 01	n	
	LOCATION	DATE	Eugene Jong-Hyon Baik

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	LOCATION , or	DATE	Simone Merlin
Done at _	LOCATION O	ñ	XX - 2014
	LOCATION	DATE	Bin Tian
Done at	San Pier . n	n <u>30 / k / m</u> DATE	of the state of th
	LOCATION	DATE	Sameer Vermani
Done at	. 01	n	
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Done at	, on		
	LOCATION	DATE	Simone Merlin
Done at	, on		
	LOCATION on_		Bin Tian
	LOCATION on		Sameer Vermani
Done at _	San Jose, CA, on_ LOCATION	a/11/14	gun but
	LOCATION	DATE	Eugene Jong-Hyon Baik

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> PATENT REEL: 034163 FRAME: 0767

RECORDED: 11/13/2014